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Claims 1-53 (Cancelled)

- 54. (Currently Amended)[The] <u>A</u> method [of claim 36] <u>of utilizing a microband electrode</u> <u>array sensor comprising a substrate having a first edge;</u>
 - a layer of insulating material on top of said substrate, said layer of insulating material having a first edge;

said first edge of said substrate and said first edge of said insulating material aligned to form a single edge;

a plurality of microband electrodes between said substrate and said layer of insulating material, a surface of each of said microband electrodes exposed at said single edge wherein the exposed surface of each of said microband electrodes has a width less than about 25 micrometers and a thickness less than about 25 micrometers and;

a plurality of gaps, one gap between each of two adjacent microband electrodes and each of said gaps having a length great enough that no substantial overlap of diffusion layers occurs; said method comprising the steps of:

- (a) contacting said sensor with a sample suspected of containing an analyte; and
- (b) performing anodic stripping voltammetry
- wherein said microband electrode array sensor wherein said insulating material is chosen from the group consisting of silicon carbide, silicon nitride, and silicon dioxide.

Claims 55-68 (Cancelled)

69. (New) A method of utilizing a microband electrode array sensor comprising:

a substrate having a first edge;

a layer of insulating material having a first edge aligned with said first edge of said substrate; and

a plurality of microband electrodes between said substrate and said layer of insulating material;

C3

said microband electrodes having a surface exposed at said first edges of said substrate and said insulating layer, said insulating material forming a plurality of gaps, wherein there is one gap between each of two adjacent microband electrodes, wherein the exposed surface of each of said microband electrodes has a width less than about 25 micrometers and a thickness less than about 25 micrometers; and wherein the size of each gap is selected such that in operation, the signals produced by said microband electrodes in said array are additive; which method comprises the steps of:

- (a) contacting said sensor with a sample suspected of containing an analyte; and
- (b) applying a voltage to the electrodes of said sensor and scanning the voltage over a range such that said analyte should be oxidized or reduced at said microband electrode.
- 70. (New) The method of claim 69 wherein the voltage is scanned from a negative voltage to a positive voltage.
- 71. (New) The method of claim 69 wherein said insulating material of said sensor is selected from the group consisting of silicon carbide, silicon nitride, and silicon dioxide.
- 72. (New) The method of claim 69 wherein the exposed surface of each of said microband

electrodes has a thickness of between about 0.03 and 5 micrometers.

- 73. (New) The method of claim 69 wherein the exposed surface of each of said microband electrodes has a thickness of between about 0.1 to about 0.2 micrometers.
- 74. (New) The method of claim 69 wherein the exposed surface of each of said microband electrodes has a width between 1 to 25 micrometers.
- 75. (New) The method of claim 69 wherein said microband electrode array sensor further comprises an adhesion layer between said insulating layer and said microband electrodes.
- 76. (New) The method of claim 75 wherein said adhesion layer comprises chromium.
- 77. (New) The method of claim 69 wherein said substrate is planar.
- 78. (New) The method of claim 69 wherein said sensor is integrated into a channel.
- 79. (New) The method of claim 69 wherein the sample is contacted with a plurality of layers of microband electrode array sensors separated from each other by insulating material.
- 80. (New) The method of claim 79 wherein in the multi-layer microband electrode sensors each of said substrates is planar.
- 81. (New) A method for performing electrochemical measurements on a sample comprising the step of contacting a sample suspected of containing an analyte with a microband electrode array sensor comprising:
 - a substrate having a first edge;
 - a layer of insulating material having a first edge aligned with said first edge of said substrate; and

a plurality of microband electrodes between said substrate and said layer of insulating material;

said microband electrodes having a surface exposed at said first edges of said substrate and said insulating layer, said insulating material forming a plurality of gaps, wherein there is one gap between each of two adjacent microband electrodes, wherein the exposed surface of each of said microband electrodes has a width less than about 25 micrometers and a thickness less than about 25 micrometers; and wherein the size of each gap is selected such that in operation, the signals produced by said microband electrodes in said array are additive; and

wherein the sensor is integrated into a channel

- 82. (New) The method of claim 81 wherein the electrochemical measurement conducted with said sensor is selected from the group consisting of electrogravimetry; controlled-potential coulometry; controlled-current coulometry; voltammetry; anodic- and cathodic-stripping voltammetry; cyclic voltammetry; square wave voltammetry; differential pulse voltammetry; adsorptive stripping voltammetry; potentiometric stripping analysis and amperometry.
- 83. (New) The method of claim 81 wherein the electrochemical measurement conducted with said sensor is cyclic voltammetry.
- 84. (New) The method of claim 81 wherein the electrochemical measurement conducted with said sensor is cyclic voltammetry.
- 85. (New) The method of claim 81 wherein said insulating material is selected from the group consisting of silicon carbide, silicon nitride, and silicon dioxide.

- (New) The method of claim 81 wherein the exposed surface of each of said microband 86. electrodes has a thickness of between about 0.03 and 5 micrometers.
- 87. (New) The method of claim 81 wherein the exposed surface of each of said microband electrodes has a thickness of between about 0.1 to about 0.2 micrometers.
- The method of claim 81 wherein the exposed surface of each of said microband 88. electrodes has a width of between 1 and 25 micrometers.
- 89. (New) The method of claim 81 wherein said microband electrode array sensor further comprises an adhesion layer between said insulating layer and said microband electrodes. Contal 90.
 - (New) The method of claim 89 wherein said adhesion layer comprises chromium.
 - 91. (New) A microband electrode array sensor for detecting the presence or measuring the concentration of analytes in a sample, said sensor comprising:
 - a substrate having a first edge;
 - a layer of insulating material having a first edge aligned with said first edge of said substrate; and
 - a plurality of microband electrodes between said substrate and said layer of insulating material;

said microband electrodes having a surface exposed at said first edges of said substrate and said insulating layer, said insulating material forming a plurality of gaps, wherein there is one gap between each of two adjacent microband electrodes, wherein the exposed surface of each of said microband electrodes has a width less than about 25 micrometers and a thickness less than about 25 micrometers; and wherein the size of each gap is

selected such that in operation, the signals produced by said microband electrodes in said array are additive.

- 92. (New) The microband electrode array sensor of claim 91 wherein the exposed surface of each of said microband electrodes has a thickness of between about 0.03 to about 5 micrometers.
- (New) The microband electrode array sensor of claim 91 wherein the exposed surface of each of said microband electrodes has a thickness of between about 0.1 to about 0.2 micrometers.
 - 94. (New) The microband electrode array sensor of claim 91 wherein the exposed surface of each of said microband electrodes has a width between 1 and 25 micrometers.
 - 95. (New) The microband electrode array sensor of claim 91 wherein said insulating material is selected from the group consisting of silicon carbide, silicon nitride, and silicon dioxide.